# Surface Mount Fuses Thin Film Fuse > Fast Acting > 483A Series





## **Description**

Littelfuse 483A Series AEC-Q200 qualified fuses are to cater to secondary circuit protection needs of compact auto electronics applications. The general design ensures excellent temperature stability and performance reliability.

This high I²t fuse series is designed to have ultra high inrush current withstand capability to avoid nuisance fuse open.

#### **Features**

- Operating Temperature from -55 °C to 125 °C
- 100% Lead-free, Halogen-Free and RoHS compliant
- AEC-Q200 Qualified
- Very Small 1206 Footprint
- Ultra high I²t values
- Fast Acting
- Recognized to UL/CSA/ NMX 248-1 and UL/CSA/ NMX 248-14

## **Agency Approvals**

Agency	Agency File Number	Ampere Range	
c <b>Fl</b> °us	E10480	0.750–2 A	

### **Electrical Characteristics**

% of Ampere Rating	Opening Time
100%	4 Hours, Minimum
250%	5 Seconds, Maximum

#### **Benefits**

- Single fuse solution for high current application
- Suitable for a wide variety of voltage requirements and applications

### **Applications**

- Li-Ion Battery
- LED Lighting
- Automotive Navigation System
- Battery Management System (BMS)
- Cluster

## **Additional Information**







Resources

Accessories

Samples

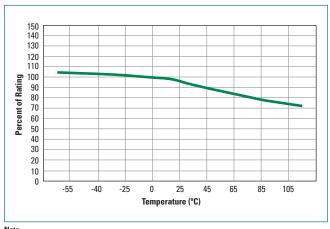
# **Electrical Specifications**

Ampere Rating	pere Rating Amp Code	Max Voltage Rating (V)	Interrupting Rating	Nominal Cold Resistance (Ohms)	Nominal Melting I <sup>2</sup> t (A <sup>2</sup> sec.)	Agency Approvals
(A)						c <b>SU</b> °us
0.750	0.750	75V	50A @ 75VDC/VAC	0.235	0.144	X
1.00	001.	75V		0.165	0.286	X
2.00	002.	75V		0.073	1.420	X

Note: I2t values stated for 1 msec opening time.

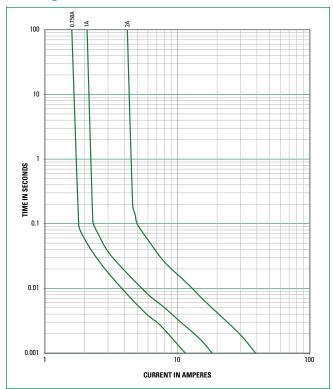
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# **Temperature Re-rating Curve**



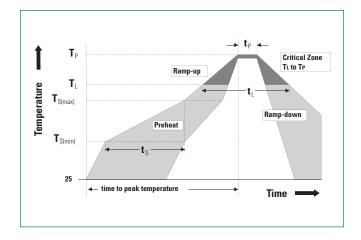
Note
Derating depicted in this curve is in addition to the standard derating of 25% for continuous operation.

# **Average Time Current Curves**



## **Soldering Perameters**

Reflow Condition		Pb – Free assembly	
Pre Heat	-Temperature Min (T <sub>s(min)</sub> )	150 °C	
	-Temperature Max (T <sub>s(max)</sub> )	200 °C	
	-Time (Min to Max) (t <sub>s</sub> )	60-180 secs	
Average ramp up rate (Liquidus Temp (T <sub>L</sub> ) to peak		5 °C/second max.	
T <sub>S(max)</sub> to T <sub>L</sub> - Ramp-up Rate		5 °C/second max.	
Reflow	-Temperature (T <sub>L</sub> ) (Liquidus)	217 °C	
	-Temperature (t <sub>L</sub> )	60-150 secs	
Peak Temperature (T <sub>p</sub> )		260+0/-5 °C	
Time within 5 °C of actual peak Temperature (tp)		20-40 seconds	
Ramp-down Rate		5 °C / second max.	
Time 25 °C to peak Temperature (T <sub>p</sub> )		8 minutes max.	
Do not exceed		260 °C	



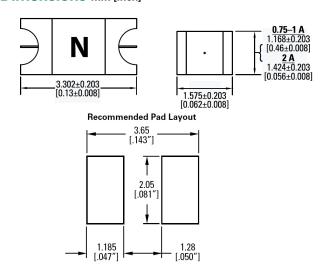


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### **Product Characteristics**

	Body: Glass-Reinforced Epoxy
Materials	<b>Terminations:</b> Cu/Ni/Sn (100% Pb-free)
Moisture Sensitivity Level	IPC/JEDEC J-STD-020, Level 1
Thermal Shock	JESD22-A104C
Biased Humidity	MIL-STD-202, Method 103, Test Condition D w/ exemptions
High Temperature Storage	MIL-STD-202, Method 108 Test Condition D w/ exemptions
High Temperature Operational Life	MIL-STD-202, Method 108, Test Condition D
Mechanical Shock	MIL-STD-202, Method 213
High Frequency Vibration	MIL-STD-202, Method 204
Resistance to Solvents	MIL-STD-202, Method 215
Resistance to Soldering Heat	MIL-STD-202, Method 210
Salt Fog	MIL-STD-202, Method 101
Moisture Resistance	MIL-STD-202, Method 106
Terminal Strength	AEC-Q200-006
Board Flex	AEC-Q200-005
Solderability	JESD22-B102E Method 1
Pulse Testing	Device Specification
Electrical Characterization	Conducted at minimum, ambient and maximum temperatures

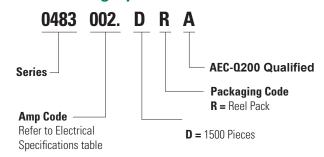
### **Dimensions** mm [inch]



## **Part Marking System**

Amp Code	Marking Code
.750	G
001.	Н
002.	N

## **Part Numbering System**



## **Packaging**

Packaging Option	Packaging Specification	Quantity	Quantity & Packaging Code	Reel Size
8 mm Tape and Reel	EIA-481	1500	DR	N / A

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